

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Kazuo Kanetsuna

Title: HEAT INSULATION PANEL SERVING ALSO AS  
MOLD FORM, AND OUTER HEAT INSULATION  
STRUCTURE

Docket No.: 41089

**PRELIMINARY AMENDMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Prior to the examination of the above-identified patent application, it is requested that the following amendments be made.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks** begin on page 6 of this paper.